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## 74VCX16601

### Low Voltage 18-Bit Universal Bus Transceivers with 3.6V Tolerant Inputs and Outputs

#### General Description

The VCX16601 is an 18-bit universal bus transceiver which combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes.

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable (CLKENAB and CLKENBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is HIGH. When LEAB is LOW, the A data is latched if CLKAB is held at a HIGH-to-LOW logic level. If LEAB is LOW, the A bus data is stored in the latch/flip-flop on the LOW-to-HIGH transition of CLKAB. When OEAB is LOW, the outputs are active. When OEAB is HIGH, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses OEBA, LEBA, CLKBA and CLKENBA.

The VCX16601 is designed for low voltage (1.4V to 3.6V)  $V_{CC}$  applications with I/O capability up to 3.6V.

The VCX16601 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

#### Features

- 1.4V to 3.6V  $V_{CC}$  supply operation
- 3.6V tolerant inputs and outputs
- $t_{PD}$  (A to B, B to A)
  - 2.9 ns max for 3.0V to 3.6V  $V_{CC}$
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- Static Drive ( $I_{OH}/I_{OL}$ )
  - $\pm 24$  mA @ 3.0V  $V_{CC}$
- Uses proprietary noise/EMI reduction circuitry
- Latchup performance exceeds 300 mA
- ESD performance:
  - Human body model > 2000V
  - Machine model >200V
- Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA) (Preliminary)

**Note 1:** To ensure the high-impedance state during power up or power down, OE should be tied to  $V_{CC}$  through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

#### Ordering Code:

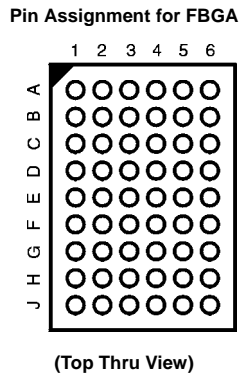
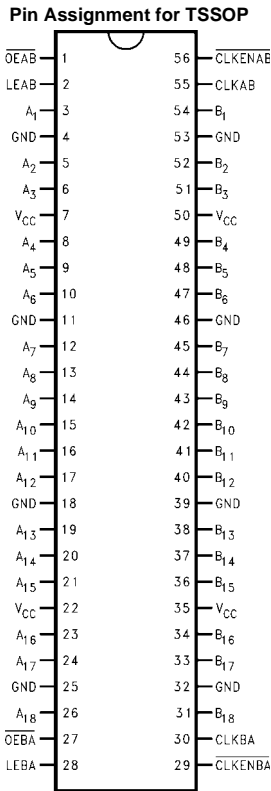
Order Number	Package Number	Package Description
74VCX16601GX (Note 2)	BGA54A (Preliminary)	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [TAPE and REEL]
74VCX16601MTD (Note 3)	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

**Note 2:** BGA package available in Tape and Reel only.

**Note 3:** Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

74VCX16601 Low Voltage 18-Bit Universal Bus Transceivers with 3.6V Tolerant Inputs and Outputs

### Connection Diagrams



### Pin Descriptions

Pin Names	Description
$\overline{OEAB}$ , $\overline{OEBA}$	Output Enable Inputs (Active LOW)
LEAB, LEBA	Latch Enable Inputs
CLKAB, CLKBA	Clock Inputs
$\overline{CLKENAB}$ , $\overline{CLKENBA}$	Clock Enable Inputs
A <sub>1</sub> -A <sub>18</sub>	Side A Inputs or 3-STATE Outputs
B <sub>1</sub> -B <sub>18</sub>	Side B Inputs or 3-STATE Outputs

### FBGA Pin Assignments

	1	2	3	4	5	6
<b>A</b>	A <sub>2</sub>	A <sub>1</sub>	$\overline{OEAB}$	$\overline{CLKENAB}$	B <sub>1</sub>	B <sub>2</sub>
<b>B</b>	A <sub>4</sub>	A <sub>3</sub>	LEAB	CLKAB	B <sub>3</sub>	B <sub>4</sub>
<b>C</b>	A <sub>6</sub>	A <sub>5</sub>	V <sub>CC</sub>	V <sub>CC</sub>	B <sub>5</sub>	B <sub>6</sub>
<b>D</b>	A <sub>8</sub>	A <sub>7</sub>	GND	GND	B <sub>7</sub>	B <sub>8</sub>
<b>E</b>	A <sub>10</sub>	A <sub>9</sub>	GND	GND	B <sub>9</sub>	B <sub>10</sub>
<b>F</b>	A <sub>12</sub>	A <sub>11</sub>	GND	GND	B <sub>11</sub>	B <sub>12</sub>
<b>G</b>	A <sub>14</sub>	A <sub>13</sub>	V <sub>CC</sub>	V <sub>CC</sub>	B <sub>13</sub>	B <sub>14</sub>
<b>H</b>	A <sub>16</sub>	A <sub>15</sub>	$\overline{OEBA}$	CLKBA	B <sub>15</sub>	B <sub>16</sub>
<b>J</b>	A <sub>17</sub>	A <sub>18</sub>	LEBA	$\overline{CLKENBA}$	B <sub>18</sub>	B <sub>17</sub>

### Truth Table

(Note 4)

Inputs					Outputs
$\overline{CLKENAB}$	$\overline{OEAB}$	LEAB	CLKAB	A <sub>n</sub>	B <sub>n</sub>
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B <sub>0</sub> (Note 5)
H	L	L	X	X	B <sub>0</sub> (Note 5)
L	L	L	↑	L	L
L	L	L	↑	H	H
L	L	L	L	X	B <sub>0</sub> (Note 5)
L	L	L	H	X	B <sub>0</sub> (Note 6)

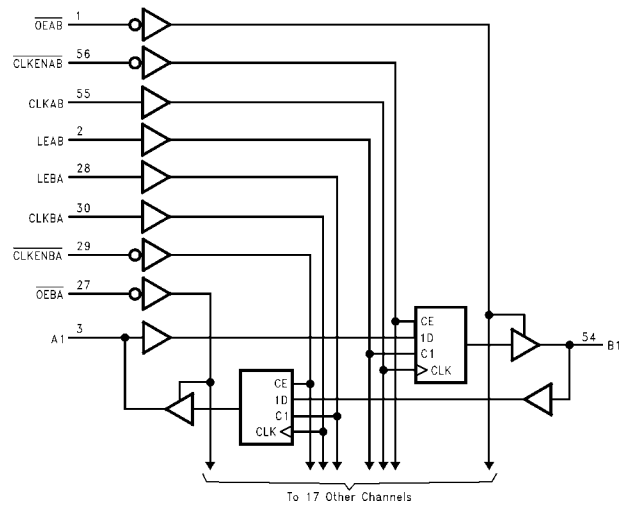
H = HIGH Voltage Level  
 L = LOW Voltage Level  
 X = Immaterial (HIGH or LOW, inputs may not float)  
 Z = High Impedance

**Note 4:** A-to-B data flow is shown; B-to-A flow is similar but uses  $\overline{OEBA}$ , LEBA, CLKBA, and  $\overline{CLKENBA}$ .

**Note 5:** Output level before the indicated steady-state input conditions were established.

**Note 6:** Output level before the indicated steady-state input conditions were established, provided that CLKAB was HIGH before LEAB went LOW.

### Logic Diagram



**Absolute Maximum Ratings** (Note 7)

Supply Voltage ( $V_{CC}$ )	-0.5V to +4.6V
DC Input Voltage ( $V_I$ )	-0.5V to +4.6V
Output Voltage ( $V_O$ )	
Outputs 3-States	-0.5V to +4.6V
Outputs Active (Note 8)	-0.5 to $V_{CC} + 0.5V$
DC Input Diode Current ( $I_{IK}$ ) $V_I < 0V$	-50 mA
DC Output Diode Current ( $I_{OK}$ )	
$V_O < 0V$	-50 mA
$V_O > V_{CC}$	+50 mA
DC Output Source/Sink Current	
( $I_{OH}/I_{OL}$ )	$\pm 50$ mA
DC $V_{CC}$ or Ground Current per	
Supply Pin ( $I_{CC}$ or Ground)	$\pm 100$ mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C

**Recommended Operating Conditions** (Note 9)

Power Supply	
Operating	1.4V to 3.6V
Input Voltage	-0.3V to 3.6V
Output Voltage ( $V_O$ )	
Output in Active States	0V to $V_{CC}$
Output in 3-STATE	0.0V to 3.6V
Output Current in $I_{OH}/I_{OL}$	
$V_{CC} = 3.0V$ to 3.6V	$\pm 24$ mA
$V_{CC} = 2.3V$ to 2.7V	$\pm 18$ mA
$V_{CC} = 1.65V$ to 2.3V	$\pm 6$ mA
$V_{CC} = 1.4V$ to 1.6V	$\pm 2$ mA
Free Air Operating Temperature ( $T_A$ )	-40°C to +85°C
Minimum Input Edge Rate ( $\Delta t/\Delta V$ )	
$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10 ns/V

**Note 7:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The Recommended Operating Conditions tables will define the conditions for actual device operation.

**Note 8:**  $I_O$  Absolute Maximum Rating must be observed.

**Note 9:** Floating or unused pin (inputs or I/O's) must be held HIGH or LOW.

**DC Electrical Characteristics**

Symbol	Parameter	Conditions	$V_{CC}$ (V)	Min	Max	Units
$V_{IH}$	HIGH Level Input Voltage		2.7 - 3.6	2.0		V
			2.3 - 2.7	1.6		
			1.65 - 2.3	$0.65 \times V_{CC}$		
			1.4 - 1.6	$0.65 \times V_{CC}$		
$V_{IL}$	LOW Level Input Voltage		2.7 - 3.6		0.8	V
			2.3 - 2.7		0.7	
			1.65 - 2.3		$0.35 - V_{CC}$	
			1.4 - 1.6		$0.35 - V_{CC}$	
$V_{OH}$	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$ $I_{OH} = -12 mA$ $I_{OH} = -18 mA$ $I_{OH} = -24 mA$	2.7 - 3.6	$V_{CC} - 0.2$		V
			2.7	2.2		
			3.0	2.4		
			3.0	2.2		
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 mA$ $I_{OH} = -12 mA$ $I_{OH} = -18 mA$	2.3 - 2.7	$V_{CC} - 0.2$		
			2.3	2.0		
			2.3	1.8		
			2.3	1.7		
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 mA$ $I_{OH} = -100 \mu A$ $I_{OH} = -2 mA$	1.65 - 2.3	$V_{CC} - 0.2$		
			1.65	1.25		
			1.4 - 1.6	$V_{CC} - 0.2$		
			1.4	1.05		

DC Electrical Characteristics (Continued)						
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	2.7 - 3.6		0.2	V
		I <sub>OL</sub> = 12 mA	2.7		0.4	
		I <sub>OL</sub> = 18 mA	3.0		0.4	
		I <sub>OL</sub> = 24 mA	3.0		0.55	
		I <sub>OL</sub> = 100 μA	2.3 - 2.7		0.2	
		I <sub>OL</sub> = 12 mA	2.3		0.4	
		I <sub>OL</sub> = 18 mA	2.3		0.6	
		I <sub>OL</sub> = 100 μA	1.65 - 2.3		0.2	
		I <sub>OL</sub> = 6 mA	1.65		0.3	
		I <sub>OL</sub> = 100 μA	1.4 - 1.6		0.2	
		I <sub>OL</sub> = 2 mA	1.4		0.35	
I <sub>I</sub>	Input Leakage Current	0V ≤ V <sub>I</sub> ≤ 3.6V	2.7 - 3.6		±5.0	μA
I <sub>OZ</sub>	3-STATE Output Leakage	0V ≤ V <sub>O</sub> ≤ 3.6V V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	1.4 - 3.6		±10.0	μA
I <sub>OFF</sub>	Power Off Leakage Current	0V ≤ (V <sub>I</sub> , V <sub>O</sub> ) ≤ 3.6V	0		10.0	μA
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND V <sub>CC</sub> ≤ (V <sub>I</sub> , V <sub>O</sub> ) ≤ 3.6V (Note 10)	1.4 - 3.6		20.0	μA
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> - 0.6V	2.7 - 3.6		750	μA
<b>Note 10:</b> Outputs disabled or 3-STATE only.						

AC Electrical Characteristics (Note 11)							
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C		Units	Figure Number
				Min	Max		
t <sub>MAX</sub>	Maximum Clock Frequency	C <sub>L</sub> = 30 pF	3.3 ± 0.3	250		MHz	
			2.5 ± 0.2	200			
			1.8 ± 0.15	100			
		C <sub>L</sub> = 15 pF	1.5 ± 0.1	80.0			
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Bus-to-Bus	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	0.8	2.9	ns	Figures 1, 2
			2.5 ± 0.2	1.0	3.5		
			1.8 ± 0.15	1.5	7.0		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2kΩ	1.5 ± 0.1	1.0	14.0		Figures 7, 8
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay Clock-to-Bus	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	0.8	3.5	ns	Figures 1, 2
			2.5 ± 0.2	1.0	4.4		
			1.8 ± 0.15	1.5	8.8		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 500Ω	1.5 ± 0.1	1.0	17.6		Figures 7, 8
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay LE-to-Bus	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	0.8	3.5	ns	Figures 1, 2
			2.5 ± 0.2	1.0	4.4		
			1.8 ± 0.15	1.5	8.8		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 500Ω	1.5 ± 0.1	1.0	17.6		Figures 7, 8
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	0.8	3.8	ns	Figures 1, 3, 4
			2.5 ± 0.2	1.0	4.9		
			1.8 ± 0.15	1.5	9.8		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2kΩ	1.5 ± 0.1	1.0	19.6		Figures 7, 9, 10
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	0.8	3.7	ns	Figures 1, 3, 4
			2.5 ± 0.2	1.0	4.2		
			1.8 ± 0.15	1.5	7.6		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2kΩ	1.5 ± 0.1	1.0	15.2		Figures 7, 9, 10
t <sub>S</sub>	Setup Time	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	1.5		ns	Figure 6
			2.5 ± 0.2	1.5			
			1.8 ± 0.15	2.5			
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 500Ω	1.5 ± 0.1	3.0			
t <sub>H</sub>	Hold Time	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	1.0		ns	Figure 6
			2.5 ± 0.2	1.0			
			1.8 ± 0.15	1.0			
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 500Ω	1.5 ± 0.1	2.0			
t <sub>W</sub>	Pulse Width	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3	1.5		ns	Figure 5
			2.5 ± 0.2	1.5			
			1.8 ± 0.15	4.0			
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 500Ω	1.5 ± 0.1	4.0			
t <sub>OSHL</sub> t <sub>OSLH</sub>	Output to Output Skew (Note 12)	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500Ω	3.3 ± 0.3		0.5	ns	
			2.5 ± 0.2		0.5		
			1.8 ± 0.15		0.75		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2kΩ	1.5 ± 0.1		1.5		

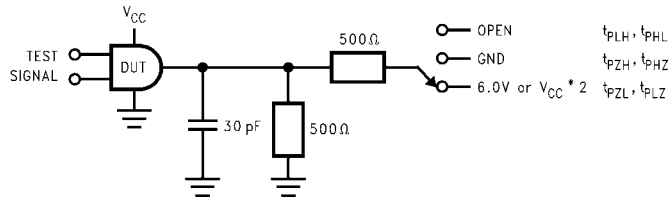
**Note 11:** For C<sub>L</sub> = 50pF, add approximately 300ps to the AC maximum specification.

**Note 12:** Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

Dynamic Switching Characteristics					
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = +25°C	Units
				Typical	
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = V <sub>CC</sub> , V <sub>IL</sub> = 0V	1.8	0.25	V
			2.5	0.6	
			3.3	0.8	
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = V <sub>CC</sub> , V <sub>IL</sub> = 0V	1.8	-0.25	V
			2.5	-0.6	
			3.3	-0.8	
V <sub>OHV</sub>	Quiet Output Dynamic Valley V <sub>OH</sub>	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = V <sub>CC</sub> , V <sub>IL</sub> = 0V	1.8	1.5	V
			2.5	1.9	
			3.3	2.2	
Capacitance					
Symbol	Parameter	Conditions	T <sub>A</sub> = +25°C		Units
C <sub>IN</sub>	Input Capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub> V <sub>CC</sub> = 1.8V, 2.5V, or 3.3V	6.0		pF
C <sub>IO</sub>	Output Capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub> , V <sub>CC</sub> = 1.8V, 2.5V or 3.3V	7.0		pF
C <sub>PD</sub>	Power Dissipation Capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub> , f = 10 MHz V <sub>CC</sub> = 1.8V, 2.5V or 3.3V	20.0		pF

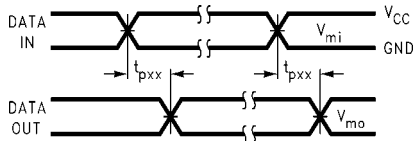


**AC Loading and Waveforms ( $V_{CC}$  3.3V ± 0.3V to 1.8V ± 0.15V)**

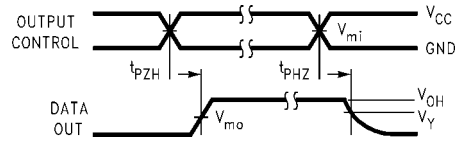


**FIGURE 1. AC Test Circuit**

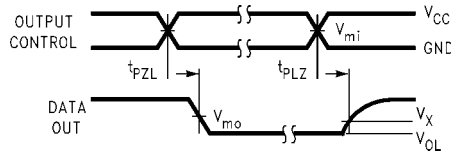
TEST	SWITCH
$t_{PLH}, t_{PHL}$	Open
$t_{PZL}, t_{PLZ}$	6V at $V_{CC} = 3.3V \pm 0.3V$ ; $V_{CC} \times 2$ at $V_{CC} = 2.5V \pm 0.2V; 1.8V \pm 0.15V$
$t_{PZH}, t_{PHZ}$	GND



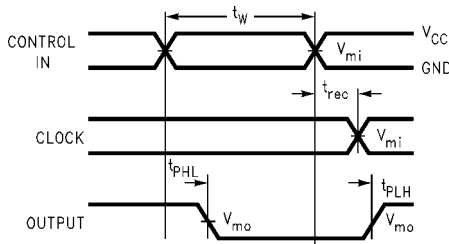
**FIGURE 2. Waveform for Inverting and Non-inverting Functions**



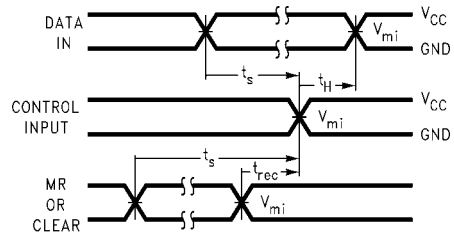
**FIGURE 3. 3-STATE Output High Enable and Disable Times for Low Voltage Logic**



**FIGURE 4. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic**



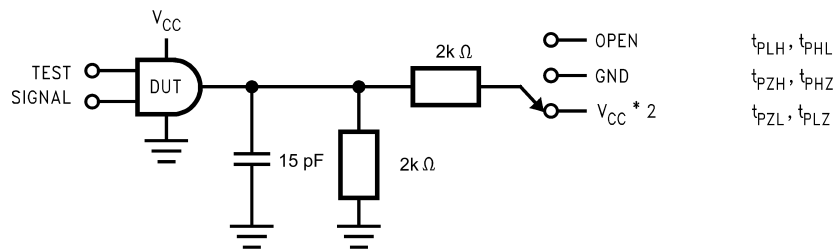
**FIGURE 5. Propagation Delay, Pulse Width and  $t_{rec}$  Waveforms**



**FIGURE 6. Setup Time, Hold Time and Recovery Time for Low Voltage Logic**

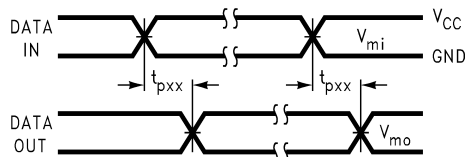
Symbol	$V_{CC}$		
	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V
$V_{mi}$	1.5V	$V_{CC}/2$	$V_{CC}/2$
$V_{mo}$	1.5V	$V_{CC}/2$	$V_{CC}/2$
$V_X$	$V_{OL} + 0.3V$	$V_{OL} + 0.15V$	$V_{OL} + 0.15V$
$V_Y$	$V_{OH} - 0.3V$	$V_{OH} - 0.15V$	$V_{OH} - 0.15V$

**AC Loading and Waveforms ( $V_{CC} 1.5V \pm 0.1V$ )**

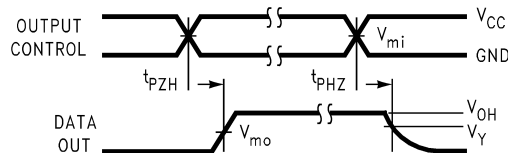


TEST	SWITCH
$t_{PLH}, t_{PHL}$	Open
$t_{PZL}, t_{PLZ}$	$V_{CC} \times 2$ at $V_{CC} = 1.5 \pm 0.1V$
$t_{PZH}, t_{PHZ}$	GND

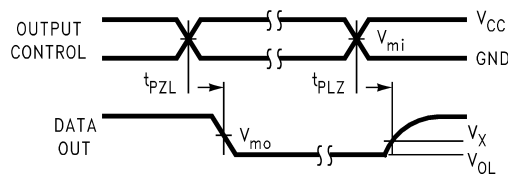
**FIGURE 7. AC Test Circuit**



**FIGURE 8. Waveform for Inverting and Non-inverting Functions**



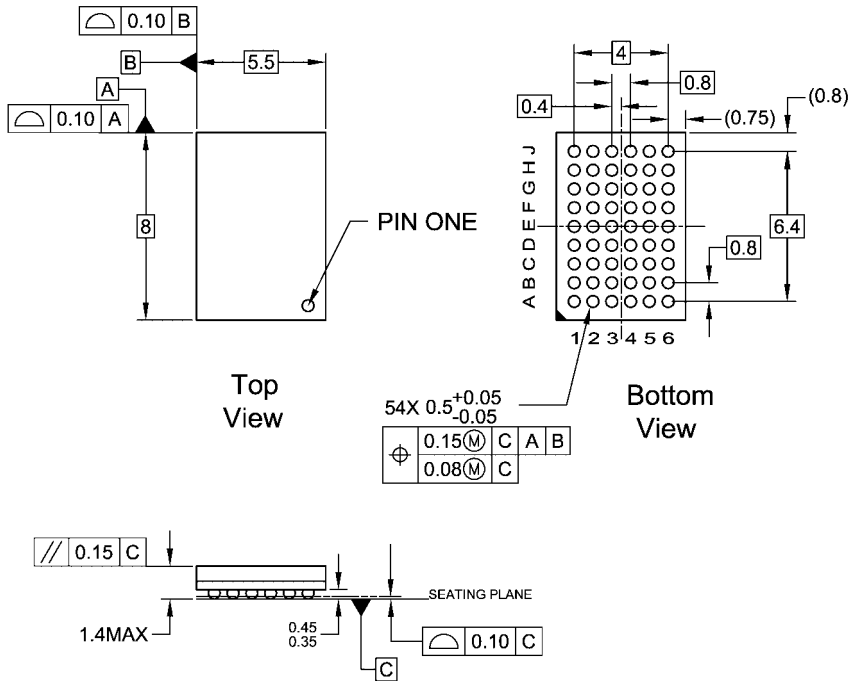
**FIGURE 9. 3-STATE Output High Enable and Disable Times for Low Voltage Logic**



**FIGURE 10. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic**

Symbol	$V_{CC}$
	$1.5V \pm 0.1V$
$V_{mi}$	$V_{CC}/2$
$V_{mo}$	$V_{CC}/2$
$V_X$	$V_{OL} + 0.1V$
$V_Y$	$V_{OH} - 0.1V$

**Physical Dimensions** inches (millimeters) unless otherwise noted



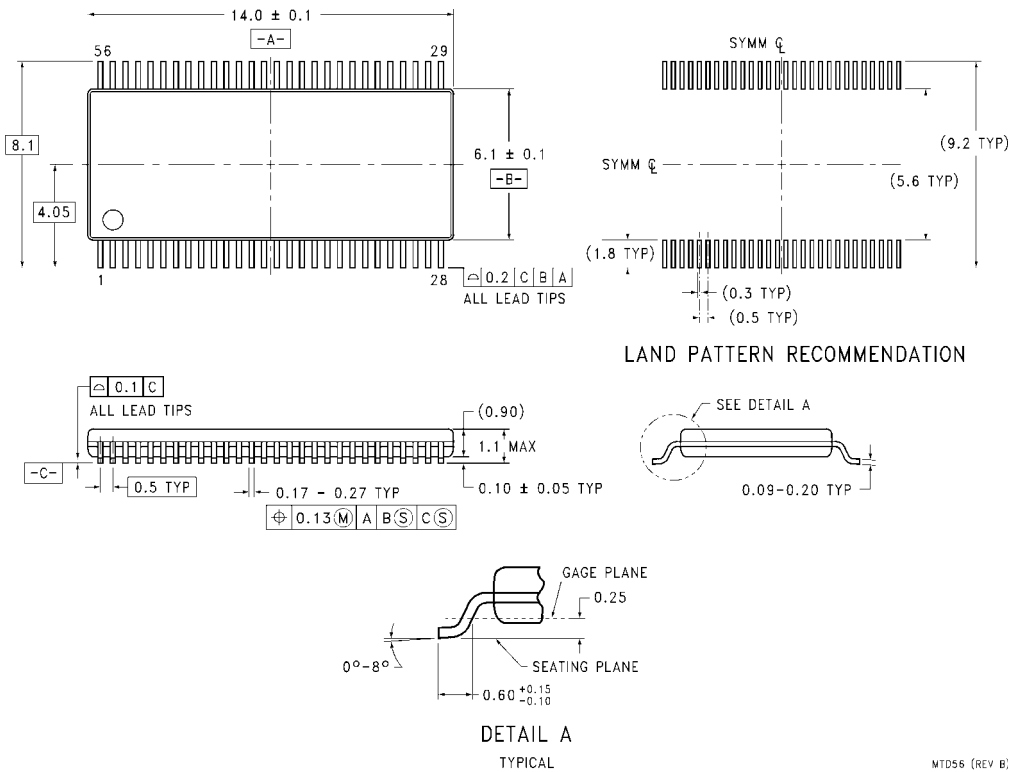
**NOTES:**

- A. THIS PACKAGE CONFORMS TO JEDEC M0-205
- B. ALL DIMENSIONS IN MILLIMETERS
- C. LAND PATTERN RECOMMENDATION: NSMD (Non Solder Mask Defined)  
.35MM DIA PADS WITH A SOLDERMASK OPENING OF .45MM CONCENTRIC TO PADS
- D. DRAWING CONFORMS TO ASME Y14.5M-1994

BGA54ArevD

**54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide  
Package Number BGA54A  
(Preliminary)**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide  
Package Number MTD56**

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